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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/523,990	03/13/2000	Mou-Shiung Lin	085027-0026	6138
89518 7590 05/28/2012 McDemott Will & Emery LLP 600 13th Street, NW Washington, DC 20005-3096		EXAM	IINER	
			WALSH,	DANIEL I
			ART UNIT	PAPER NUMBER
			2887	
			NOTIFICATION DATE	DELIVERY MODE
			05/23/2012	ELECTRONIC

## Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

mweipdocket@mwe.com SIP\_Docket@mwe.com ocpat\_uspto@qualcomm.com

## Office Action Summary

Application No.	Applicant(s)	
09/523,990	LIN ET AL.	
Examiner	Art Unit	
DANIEL WALSH	2887	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address -- Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS,

- WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.
- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filled
  - after SIX (6) MONTHS from the mailing date of this communication.

    If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
   Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any
  - earned patent term adjustment. See 37 CFR 1.704(b).

Status	
1)🛛	Responsive to communication(s) filed on 14 May 2012.
2a) 🖂	This action is <b>FINAL</b> . 2b) ☐ This action is non-final.

- An election was made by the applicant in response to a restriction requirement set forth during the interview on the restriction requirement and election have been incorporated into this action.
- 4) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.

#### **Disposition of Claims**

5) 🛛	Claim(s) <u>44,48,49 and 60-68</u> is	are pending in the application.
	5a) Of the above claim(s)	is/are withdrawn from consideration.
6)	Claim(s) is/are allowed.	

- 7) Claim(s) 44,48,49 and 60-68 is/are rejected.
- 8) Claim(s) is/are objected to.
- 9) Claim(s) are subject to restriction and/or election requirement.

## **Application Papers**

- 10) The specification is objected to by the Examiner.
- 11) The drawing(s) filed on \_\_\_\_\_ is/are: a) accepted or b) objected to by the Examiner.

Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).

Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).

12) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

## Priority under 35 U.S.C. § 119

13) Ackno	wledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
a)□ All	b) ☐ Some * c) ☐ None of:
1.	Certified copies of the priority documents have been received.
2.	Certified copies of the priority documents have been received in Application No
3 □	Copies of the certified copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in this National Copies of the priority documents have been received in the priority documents have been re

application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

#### Attachment(s)

	Notice of References Cited (PTO-892)
21 🗆	Notice of Draftsperson's Patent Drawing Review (PTO-948)

B) 🔲	Information Disclosure Statement(s) (PTO/SB/08)	
	Paper Na(c)/L/oil Date	

Interview Summary (PTO-413)
 Paper No(s)/Mail Date. \_\_\_\_\_.

 Notice of Informal Patent Application.

### DETAILED ACTION

#### Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

 Claims 65-68 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Claim 65 recites the limitation "said identity of product" in the last line of the claim.

There is insufficient antecedent basis for this limitation in the claim.

For purposes of Examination the Examiner will interpret it to read on "said bar code".

#### Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordnary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor

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and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claims 44, 61, and 65 are rejected under 35 U.S.C. 103(a) as being unpatentable over
 Shaw et al. (US 5801067) in view of Coico et al., as discussed in the previous Office Action.

Shaw et al. teaches an integrated circuit chip 320 that has an index code applied directly to its back surface and covered with a transparent clear coat 326 where a CCD can image (FIG. 20-24). Though silent to the type of printed matter (specifically recitation of identity of product/barcode) the Examiner notes that FIG. 18 teaches various related data, including manufacturer ID which can broadly be interpreted as an identity of manufacturer. Accordingly, the Examiner notes that the type of printed matter is seen as non-functional descriptive material, not functionally related to the substrate, and as such, are not patentable, as it is merely providing information that does not change the functionality of the device. Therefore, providing such information in well-known formats (machine readable barcodes, human readable symbology, etc.) would have been an obvious expedient to provide relevant item information, and for reliability of reading/increased data storage (in the case of barcodes). Further, Shaw et al. teaches the use of barcodes (FIG. 17+ and that the index code can be any combination of symbols, characters, or numbers as desired).

Shaw et al. is silent to the circuit chip being employed in a structure comprising a substrate wherein the chip is over the substrate with a front face facing a top surface of the substrate and a back face opposite, multiple metal bumps between the maps of the chip and the top surface of the substrate.

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Coico et al. teaches a substrate (FIG. 1b and 22), a semiconductor chip (12) over a top surface of said substrate, wherein said semiconductor chip has a front surface facing said top surface of said substrate and a back surface opposite said front surface wherein the chip has multiple pads at the front surface (FIG. 1a and 1b), multiple metal bumps between the pads of the chip and the top surface of said substrate (FIG. 1a-1b, as the chip pads 10 are electrically connected to the substrate pads 16 by solder reflow, thermo compression, or conductive adhesives). Accordingly, the use of metal bumps would have been an obvious expedient to produce the expected results of electrical connectivity. Alternatively, as the substrate pads are formed on top of the substrate, the pads themselves can broadly be interpreted as metal bumps/contacts.

At the time the invention was made, it would have been obvious to one of ordinary skill in the art to combine the teachings of Shaw et al. with those of Coico et al. in order to achieve a well-known and desired circuit component structure (mounted chip) for system constraints (desired structure/layout) to produce expected results.

Re the newly added limitations regarding the layer being a colored encapsulation layer and that the product is readable through said layer as laser radiation is directed through the layer upon said identify of product, the Examiner notes the layer of Shaw et al. can be interpreted as encapsulating since it covers/coats. Though silent to color, the use of colorants and dyes are well known and conventional in the art. Accordingly, one would have been motivated to do this (color) as a matter of design variation, since the applicant has not recited in the claims that a colored covering material solves any stated problem or is for any particular purpose, and it appears that the invention would perform equally well with the prior art structure. Further, the

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Examiner notes that changing a color can be seen as a matter of design variation, for aesthetics, to increase contrast, visibility, etc. as is known in the art and previously discussed in earlier office actions. Re the newly added limitations of the laser, the Examiner notes that Shaw et al. teaches (col 14, line 28+) that a laser is passed through to read the code which is interpreted as laser radiation through the encapsulation layer to the identity of product/barcode. The Examiner notes that the selection of a specific type of optically readable code (format) is within the ordinary skill in the art to provide known techniques to encode data, wherein index code 10 is disclosed as a barcode as well.

 Claims 48-49, 60, 62-64, and 66-68 are rejected under 35 U.S.C. 103(a) as being unpatentable over Shaw et al./Coico et al., as discussed above, in view of Flip Chip, as discussed in the previous Office Action.

Re claims 48-49, Shaw et al./Coico et al. are silent to underfill and multiple balls.

However, Coico et al. teaches the use of flip chips (col 1, liens 21+ and 45+) and how Coico et al. is directed to assist in their placement.

Flip Chip teaches flip chips with a BGA (page 1-2), including underfill between the substrate and chip and around the metal bumps/contacts, and multiple balls on the bottom surface of the substrate.

At the time the invention was made, it would have been obvious to one of ordinary skill in the art to combine the teachings of Shaw et al./Coico et al. with those of Flip Chip.

One would have been motivated to do this in order to have a well-known and conventional means to package a flip chip for low cost and reliability, increased performance, size, etc..

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Re claim 60, the solder has been discussed above (see sole figure of Flip Chip).

Re claims 61 and 65, the limitations have been discussed above, wherein the Examiner notes that the type of printed matter/identification information on the chip is a matter of printed matter/intended use not functionally related to the substrate thereon, and therefore is not patentably distinct from the prior art which teaches markings on the substrate as discussed above.

Alternatively, since the claims and specification do not specifically recite or preclude such an interpretation, the Examiner notes that an identity of manufacturer could be identified from the alignment markings, or from the arrangement of the chip/substrate itself, from the barcode, etc. and such an interpretation is not preclude by the claims or specification, since they do not recite that the identity is actually printed or formed on the chip, but merely that it is on the backside. Therefore, it would have been obvious to identity based on the backside of the component itself, by recognizing the chip and therefore its manufacturer.

Re claims 62-68, the limitations have been discussed above, wherein the type of printed matter/information provided is not patentably distinct over the prior art since it is not functionally related to the substrate and is a matter of intended used.

Claim 65 is rejected under 35 U.S.C. 103(a) as being unpatentable over Shaw et al./Coico
et al., as discussed above, in view of view of Hikita et al., as discussed in the previous Office
Action.

The teachings of Shaw et al. /Coico et al. have been discussed above.

Shaw et al. / Coico et al. are silent to a barcode.

Hikita et al. teaches that barcodes can be printed/laser applied directly onto each IC 10 or on the package (FIG. 15).

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At the time the invention was made, it would have been obvious to one of ordinary skill in the art to combine the teachings of Shaw et al. /Coico et al. with those of Hikita et al.

One would have been motivated to do this to provide a cost effective means for identification of a chip.

The Examiner notes nonfunctional descriptive material doesn't patentably distinguish the claims from prior art with different types of printed/identifying information/marks, etc., as they are all alternative means/printed/marked of providing information and is not functionally related to the substrate as it merely provides information without altering functionality (see In re Gulack/Ngai). This also applies to the "identity of manufacturer" and "barcode" for claims 61, 65, and their dependents.

 Claims 66-68 are rejected under 35 U.S.C. 103(a) as being unpatentable over Shaw et al./Coico et al., as discussed above, in view of Flip Chip, as discussed in the previous Office Action.

Re claims 48-49, Shaw et al. /Coico et al. /Hikita et al. are silent to underfill and multiple balls. However, Coico et al. teaches the use of flip chips (col 1, lines 21+ and 45+) and how Coico et al. is directed to assist in their placement.

Flip Chip teaches flip chips with a BGA (page 1-2), including underfill between the substrate and chip and around the metal bumps/contacts, and multiple balls on the bottom surface of the substrate.

At the time the invention was made, it would have been obvious to one of ordinary skill in the art to combine the teachings of Shaw et al. /Coico et al. /Hikita et al. with those of Flip Chip.

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One would have been motivated to do this in order to have a well-known and conventional means to package a flip chip for low cost and reliability, increased performance, size, etc.

Re claim 65, the limitations have been discussed above, wherein the Examiner notes that the type of printed matter/identification information on the chip is a matter of printed matter/intended use not functionally related to the substrate thereon, and therefore is not patentably distinct from the prior art which teaches markings on the substrate as discussed above.

Alternatively, since the claims and specification do not specifically recite or preclude such an interpretation, the Examiner notes that an identity of manufacturer could be identified from the alignment markings, or from the arrangement of the chip/substrate itself, from the barcode, etc. and such an interpretation is not preclude by the claims or specification, since they do not recite that the identity is actually printed or formed on the chip, but merely that it is on the backside. Therefore, it would have been obvious to identity based on the backside of the component itself, by recognizing the chip and therefore its manufacturer.

Re claims 66-68, the limitations have been discussed above, wherein the type of printed matter/information provided is not patentably distinct over the prior art since it is not functionally related to the substrate, does not provide additional functionality aside from providing information and can be seen as a matter of intended used.

#### Response to Arguments

Applicant's arguments filed have been fully considered but they are not persuasive. The Examiner notes that though the prior art is silent to the protective layer being colored, the Examiner notes that one would have been motivated to do this as a matter of design variation, since the applicant has not recited in the claim that a colored covering material solves any stated problem or is for any particular purpose, and it appears that the invention would perform equally well with a transparent covering. Additionally, the Examiner notes that the use of dyes and colorants are well known and conventional in the art, and therefore one would have been motivated to have a colored transparent layer for aesthetics, contrast, etc. as well known in the art and as documented in previous office actions.

If the use of the specific color provides a benefit aside from aesthetics, the Examiner suggests reciting such limitations within the body of the claim, such as to overcome the aforementioned rejection. For example, if the color is processed or otherwise read or information electronically obtained from the color (aside from just providing aesthetics/contrast/visible identification) such limitations should be recited.

### Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Ehrichs et al. (US 6593168) teaches a circuit component comprising a substrate (18), a semiconductor chip (10) over a top surface of said substrate, wherein said semiconductor chip has a front surface facing said top surface of said substrate and a back surface opposite said front surface, wherein said semiconductor chip comprises multiple pads (20) at said front surface.

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markings on said front surface of said semiconductor chip (alignment marks, FIG. 1-2), multiple bumps (20) between said multiple pads of said semiconductor chip and said top surface of said substrate. The Examiner notes that (col 5, lines 42+) teaches that the alignment marks can be formed during previous processing steps such that the marks are covered and visible through insulating layer 13, but Ehrichs et al. is silent to the markings/identity of product being visible through an optically transparent layer and wherein the identity of product is directly on the back surface of the chip, instead of the front.

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DANIEL WALSH whose telephone number is (571)272-2409. The examiner can normally be reached on M-F 9am-7pm.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Steven Paik can be reached on 571-272-2404. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/DANIEL WALSH/ Primary Examiner, Art Unit 2887